

RX Family

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Open Source FAT File System [M3S-TFAT-Tiny] Module Firmware Integration Technology

Introduction

This application note explains about RX Family Open Source FAT Filesystem M3S-TFAT-Tiny (hereafter TFAT Library) using Firmware Integration Technology (FIT).

TFAT Library is no relation to Microsoft Transaction-Safe FAT File System (TFAT).

Library build is needed for TFAT setting changing(ex. Long file name on/off feature). If user needs to change the settings, the library build environment(with source code) is needed. If user needs this one, please contact customer support (http://www.renesas.com/contact/).

Target Device

RX Family

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1. Outline

TFAT Library is FAT File system software library that concerned about low-memory usage.

The TFAT library was made based on FatFs. Please refer to the User's Manual to know the relation about source code version.

What is FatFs?

FatFs is the File system module for the small embedded system. Fat Fs is developed by ChaN Software. FatFs is provided as non-payment for embedded system. Please refer to the Website below for more details.

http://elm-chan.org/fsw/ff/00index e.html

1.1 Specification of library

1.1.1 Specification of TFAT library

Following are some of the main specifications of the TFAT library.

Table 1.1 Specification of TFAT library

item	specifications
Base program	Fatfs (R0.09b)
Supported FAT Type	FAT16, FAT32
Filename Support	8.3 format (8 lettered filename & 3 lettered extension) s
Filesystem format function	None
Number of drives supported	1
Logical Sector size	512byte

1.1.2 Structure of software stack

Following are structure of software stack of the TFAT library.

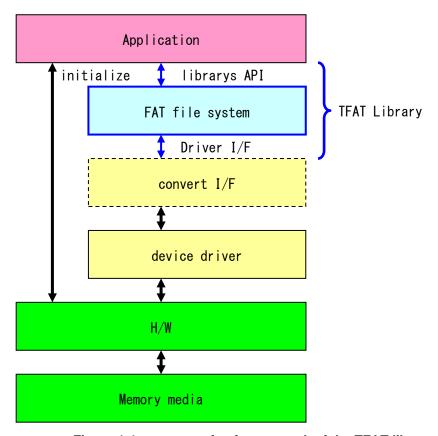


Figure 1-1 structure of software stack of the TFAT library

1.1.3 Compiler option for generating library

Library file is built with the following compiler option.

- TFAT Library file for the RX600 series (big endian)
 - -cpu=rx600 -endian=big -include="\$(WORKSPDIR)\..\pub_include"
 - -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
- TFAT Library file for the RX600 series (little endian)
 - $-cpu=rx600 include="\$(WORKSPDIR)\..\pub_include" output=obj="\$(CONFIGDIR)\.\$(FILELEAF).obj" nologo$
- TFAT Library file for the RX200 series (big endian)
 - -cpu=rx200 -endian=big -include="\$(WORKSPDIR)\..\pub_include"
 - -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -nologo
- TFAT Library file for the RX200 series (little endian)
 - $-cpu=rx200 include = "\$(WORKSPDIR) \ ... \ pub_include "-output=obj="\$(CONFIGDIR) \ \$(FILELEAF).obj "-nologo output=obj="$(CONFIGDIR) \ ... \ pub_include "-output=obj="$(CONFIGDIR) \ ... \ pub_include "-outp$

1.1.4 Version information

TFAT library has version information as strings. User can access this version information to use extern variable defined in header file.

define: extern const mw_version_t R_tfat_version;

TFAT library has version information showed below.

- RX200 Big endian
 - compiler_version = 0x1020100
 - library_info = "M3S-TFAT-Tiny version 3.01 for RX200 BIG endian.(Dec 5 2014, 14:18:45)"
- RX200 Little endian
 - compiler_version = 0x1020100
 - library_info = "M3S-TFAT-Tiny version 3.01 for RX200 LITTLE endian.(Dec 5 2014, 14:19:11)"
- RX600 Big endian
 - compiler_version = 0x1020100
 - library_info = "M3S-TFAT-Tiny version 3.01 for RX600 BIG endian.(Dec 5 2014, 14:19:26)"
- RX600 Little endian
 - compiler_version = 0x1020100
 - library_info = "M3S-TFAT-Tiny version 3.01 for RX600 LITTLE endian.(Dec 5 2014, 14:19:43)"

1.1.5 ROM size / RAM size / Stack size

TFAT library requires ROM/RAM/Stack size as below.

Table 1.2 ROM/RAM size

Section (Section name)	size		
	RX600	RX200	
ROM (P, C)	About 5.1KB	About 5.1KB	
RAM (B)	6byte	6byte	

Table 1.3 stack size

		(No memory tware)[byte]	stack size (with MMC driver(*) software)[byte]		stack size (with MMC driver(*) and USB driver software)[byte]	
	RX600	RX200	RX600	RX200	RX600	
R_tfat_f_mount	4	4	4	4	4	
R_tfat_f_open	172	172	320	320	596	
R_tfat_f_close	60	60	208	208	412	
R_tfat_f_read	84	84	232	232	444	
R_tfat_f_write	120	120	268	268	464	
R_tfat_f_lseek	100	100	248	248	456	
R_tfat_f_truncate	88	88	236	236	444	
R_tfat_f_sync	52	52	200	200	404	
R_tfat_f_opendir	132	132	280	280	524	
R_tfat_f_readdir	80	80	228	228	508	
R_tfat_f_getfree	96	96	244	244	452	
R_tfat_f_stat	152	152	300	300	556	
R_tfat_f_mkdir	172	172	320	320	596	
R_tfat_f_unlink	152	152	300	300	596	
R_tfat_f_chmod	152	152	300	300	556	
R_tfat_f_utime	148	148	296	296	552	
R_tfat_f_rename	188	188	336	336	640	
R_tfat_f_forward	76	76	224	224	440	

Note: Stack size is dependent on user-defined function.

At least one variable of the structure FATFS is always required for FileSystem Work Area allocation. The FIL and DIR structures will be needed as per the requirement. The number of FIL variables needed is equal to the number of files that will be opened simultaneously by the user. If two files are to be opened simultaneously, then two FIL structure variables will be needed resulting in total memory consumption of $32 \times 2 = 64$ Bytes. Likewise will be the case with DIR and other structure variables.

Table 1.4 structure size

Structure	Memory for one structure variable [byte]
FATFS	560
FIL	36
DIR	20
FILINFO	24

1.1.6 Performance

The access time that TFAT library reads/write memory card is below.

Table 1.5 Performance

	Test Condition	Time	
RX210	Time to write 1MByte data file.	About 4 Sec	_
	(File Open , Data write ,File close)		
	Time to read 1MByte data file.	About 2.6 Sec	_
	(File Open , Data read ,File close)		
RX610	Time to write 1MByte data file.	About 3.4 Sec	_
	(File Open , Data write ,File close)		
	Time to read 1MByte data file.	About 2.7 Sec	_
	(File Open , Data read ,File close)		
RX62N	Time to write 1MByte data file.	About 2.7 Sec	_
	(File Open , Data write ,File close)		
	Time to read 1MByte data file.	About 1.8 Sec	_
	(File Open , Data read ,File close)		

Detail of test condition is below.

Table 1.6 Measurement condition

RX210	CPU Clock(ICLK)	50MHz
_	Peripheral Clock(PCLKB)	25MHz
_	Memory	Transcend MMC 256MB
_	FAT type	FAT32
_	Driver software	Renesas MMC driver
_	Source data area when data write.	Internal ROM
	Destination data area when data read.	Internal RAM
RX610	CPU Clock(ICLK)	100MHz
_	Peripheral Clock(PCLK)	50MHz
_	Memory	Transcend MMC 256MB
_	FAT type	FAT32
_	Driver software	Renesas MMC driver
_	Source data area when data write.	Internal ROM
_	Destination data area when data read.	Internal RAM
RX62N	CPU Clock(ICLK)	96MHz
_	Peripheral Clock(PCLK)	48MHz
_	Memory	Transcend MMC 256MB
_	FAT type	FAT32
_	Driver software	Renesas MMC driver
_	Source data area when data write.	Internal ROM
	Destination data area when data read.	Internal RAM
- - - - -	FAT type Driver software Source data area when data write. Destination data area when data read. CPU Clock(ICLK) Peripheral Clock(PCLK) Memory FAT type Driver software Source data area when data write. Destination data area when data read. CPU Clock(ICLK) Peripheral Clock(PCLK) Memory FAT type Driver software Source data area when data read. CPU Clock(ICLK) Peripheral Clock(PCLK) Memory FAT type Driver software Source data area when data write.	Renesas MMC driver Internal ROM Internal RAM 100MHz 50MHz Transcend MMC 256MB FAT32 Renesas MMC driver Internal ROM Internal RAM 96MHz 48MHz Transcend MMC 256MB FAT32 Renesas MMC driver

1.2 **Usage of Libraries**

Please include a library file and a header file in a project.

RX200 series and RX113 uses TFAT library for RX200. RX600 series and RX71M uses TFAT library for RX600.

TFAT library does not contain the driver of a memory media (SD card and a USB memory). Please prepare the driver of a memory media by the user side in accordance with the hardware of use.

Please set the driver of a memory media by Memory driver interface of TFAT library. Please refer to a user's manual about Memory driver interface.

2. **API Information**

2.1 **Hardware Requirements**

None

2.2 Software Requirements

None

2.3 **Supported Toolchains**

This library is tested and working with following toolchains: Renesas RX Toolchain V.1.02 Release 01

2.4 Limitations

Library is using the following standard function

memset memcmp memcpy

2.5 **Header Files**

All API calls are accessed by including a single file "r_ffat_lib.h" which is supplied with this software's project code. Build-time configuration options are selected or defined in the file "r_tfat_rx_config.h"

2.6 **Configuration Overview**

All configurable options that can be set at build time are located in the file "r_tfat_rx_config.h".

2.7 Adding Library to Your Project

Please refer to the Adding Firmware Integration Technology Modules to Projects "r01an1723eu0110 rx.pdf".

Lib folder has all TFAT Libraries for RX Family. If user implements using the scheme that is explained in this document, all TFAT Libraries will be linked for building. Please remove the Libraries excluding your needing libraries.

3. API(Library) Functions

TFAT Library uses the following APIs.

Table 3.1 API(Library) Functions

API	Outline
R_tfat_f_mount	Register/Unregister a work area
R_tfat_f_open	Open/Create a file
R_tfat_f_close	Close a file
R_tfat_f_read	Read file
R_tfat_f_write	Write file
R_tfat_f_lseek	Move read/write pointer, Expand file size
R_tfat_f_truncate	Truncate file size
R_tfat_f_sync	Flush cached data
R_tfat_f_opendir	Open a directory
R_tfat_f_readdir	Read a directory item
R_tfat_f_getfree	Get free clusters
R_tfat_f_stat	Get file status
R_tfat_f_mkdir	Create a directory
R_tfat_f_unlink	Remove a file or directory
R_tfat_f_chmod	Change attribute
R_tfat_f_utime	Change timestamp
R_tfat_f_rename	Rename/Move a file or directory
R_tfat_f_forward	Forward file data to the stream directly

Please refer to the User's Manual if you needs datails. (r20uw0078ej0300_tfat.pdf)

4. Library version information

Ver	change
3.01	Updated version number.
3.00	V.2.00→V.3.00 can use Multidrive feature.

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Revision History

Description

Rev.	Date	Page	Summary	
3.01	Dec.28.2014	_	Corresponded to RX71M/RX113.	
			Updated the FIT for xml file.	
3.00	Apr 01, 2014	_	FIT Module correspondence	
1.03	Nov 30, 2013	_	Changed the base version of the open source into V0.09b from	
			V0.06.	
1.02	Nov 08, 2013	_	Changed document title	
			Changed the structure of sections	
			Added Fatfs copyright to library source	
1.01	Sep 01, 2012	_	RX210 correspondence	
1.00	Oct 08, 2010	_	First edition issued	

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.
- 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

— The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal.
 Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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Renesas Electronics America Inc. 2801 Scott Boulevard Santa Clara, CA 95050-2549, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne e End, Buckinghamshire, SL8 5FH, U.K

Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100191, P.R.China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, P. R. China 200333
Tei: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tei: +852-2265-6688, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hylflux Innovation Centre, Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd. 12F., 234 Teheran-ro, Gangnam-Ku, Seoul, 135-920, Korea Tel: +82-2-558-3737, Fax: +82-2-558-5141

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